

Title (en)

Trench wall cutting apparatus and method for building a diaphragm wall in the ground

Title (de)

Schlitzwandfräse und Verfahren zum Herstellen einer Schlitzwand im Boden

Title (fr)

Fraiseuse à rideau souterrain et procédé pour creuser des tranchées dans le sol

Publication

**EP 1752583 A3 20080402 (DE)**

Application

**EP 06024531 A 20040115**

Priority

- EP 04000766 A 20040115
- DE 10308538 A 20030227

Abstract (en)

[origin: EP1452645A1] A method for preparing underground slit walls has a slitting head (10) comprising a support frame (10) with one or two rotating cutting discs (12, 12') lowered into the ground by a telescopic support. The slitting head removes materials from under the head and the spoil is directed to the void above the head. At the same time a binding fluid is injected into the spoil via a duct (41) terminating at the slitting head. The slit is cut by repeated raising and lowering of the slitting head, which mixes the setting fluid with the spoil. The spoil and setting fluid set eventually to form the slit wall.

IPC 8 full level

**E02D 17/13** (2006.01); **E02F 5/08** (2006.01); **E02D 5/18** (2006.01); **E02D 5/20** (2006.01); **E02D 5/46** (2006.01); **E02F 3/20** (2006.01);  
**E02F 5/02** (2006.01); **E21B 10/08** (2006.01); **E21B 17/07** (2006.01)

CPC (source: EP KR US)

**E02D 17/13** (2013.01 - EP US); **E02F 3/205** (2013.01 - EP US); **E21B 10/08** (2013.01 - KR)

Citation (search report)

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DOCDB simple family (publication)

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CA 2457229 A1 20040827; CA 2457229 C 20080115; CN 1282805 C 20061101; CN 1525016 A 20040901; CN 1928262 A 20070314;  
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DE 502004004919 D1 20071025; DE 502004008606 D1 20090115; DK 1752583 T3 20090323; EP 1752583 A2 20070214;  
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SI 1752583 T1 20090630; US 2004234345 A1 20041125; US 2007044347 A1 20070301; US 7152346 B2 20061226; US 7356947 B2 20080415

DOCDB simple family (application)

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